RESEARCH PAPER

Electrowetting force and velocity dependence on fluid surface energy

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Received: 15 October 2014 / Accepted: 31 January 2015 / Published online: 26 February 2015 © Springer-Verlag Berlin Heidelberg 2015

Abstract Electrowetting on dielectric is a phenomenon in which the shape and apparent contact angle of a droplet changes when an electric field is applied across the droplet interface. If the field is asymmetric with respect to the droplet, then a net force can be applied to the droplet. In this work, we have measured the electrowetting force by confining the droplet shape beneath a glass plate and measuring the force on the plate. The force was measured as a function of voltage for a range of fluids with different surface energy. Measured forces show excellent agreement with predictions based on the Young–Lippmann equation with measured contact angles. Results also show that the electrowetting force is independent of fluid surface energy below saturation but that the peak force is proportional to the surface tension. This work shows that lowering the surface energy of the fluid can induce larger contact angle change under the same voltage, but it has no beneficial impact on the actuation force in droplet-based actuators. In contrast, velocity tests with deformable droplets show higher speeds for lower surface energy fluids, even above their saturation voltage. However, when the droplet's shape is restrained, the highest velocity is achieved with high surface energy fluids due to the larger electrowetting actuation forces applied.

Keywords EWOD · Electrowetting force · Droplet · Contact angle · Droplet actuator · Velocity · Contact line friction

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1 Introduction

Electrowetting on dielectric (EWOD) uses an external electric field to change the apparent contact angle of a droplet on a dielectric layer. For grounded droplet configuration, a conductive liquid and a metal substrate are separated by a thin dielectric. Voltage potential is applied between the droplet and the substrate. The contact angle of the droplet follows the Young–Lippmann equation until a certain point which is referred to as the contact angle saturation (Mugele and Baret [2005](#page-8-0)). EWOD is frequently employed in optical (Smith et al. [2006](#page-8-1)), display (Hayes and Feenstra [2003](#page-8-2)), and lab-on-a-chip technologies (Cho et al. [2003\)](#page-8-3) where fluid position and shape are the primary metrics, but it also shows promise in mechanical applications including pumps (Yoon [2001\)](#page-8-4), grippers (Vasudev and Zhe [2008](#page-8-5)), switches and motors (Sen [2009](#page-8-6); Takei et al. [2010\)](#page-8-7).

For display and bio-sampling applications, motion velocity is a key metric as it improves video quality and throughput, respectively. On the other hand, the maximum force the EWOD droplet can achieve is the primary interest in designing actuators, pumps, and grippers. However, only limited direct measurements of mesoscale electrowetting force have been reported previously. Common experimental approaches use either capillary rise measurements which calculate the electrowetting force from induced hydrostatic pressure difference (Chen and Hsieh [2006\)](#page-8-8) or relate the electrowetting force to the contact angle based on the Laplace pressure across the droplet/ambient interface (Berthier et al. [2007\)](#page-8-9). Other techniques such as measuring the pressure change inside of a microfluidic channel (Jones et al. [2003\)](#page-8-10), measuring the capacitance of the droplet (Verheijen and Prins [1999\)](#page-8-11), or using an attached AFM tip (Guan et al. [2009\)](#page-8-12) have also been explored. 't Mannetje et al. ([2013\)](#page-8-13) has measured the force due to localized EW

under applied AC signal, but these measurements are limited by the strength of the wetting to the small rod used to move the droplet. Due to the complex geometry and the dynamics of the contact line, direct force data are scarce.

This paper addresses this gap in experimental investigations in electrowetting forces and their dependence on the fluid properties. In this work, we address how the EW force varies with the applied electrical potential and the surface energy/surface tension (*γ*) of the droplet/ambient interface. First, the force relationships for electrowetting of a droplet with respect to the contact line length are developed. Experimental method for directly measuring the electrowetting force is described, and the results are compared to the conventional contact angle approximation. Velocity of droplets of high and low surface energy fluids are compared between a free deformable drop and a constrained drop. Design considerations for EWOD actuators are discussed, and the relationship of these measurements to prior velocity testing results is discussed.

2 Electrowetting force

For an arbitrary shape droplet during EWOD actuation, the change in contact angle is induced by the electric field between the fluid–dielectric interface. The force acting near the interface per unit length of contact line can be expressed as:

$$
\bar{\mathbf{F}} = \frac{\varepsilon_0 \times \varepsilon}{2 \times \delta} \times \bar{\mathbf{V}}^2 \tag{1}
$$

where ε_0 is the permittivity of free space, ε is the dielectric constant of the insulating layer, and δ is the dielectric thickness (Jones [2009](#page-8-14)). The electrowetting force can be calculated by integrating around the droplet contact line covering the active electrode (see Fig. [1](#page-1-0)):

$$
F_{\text{Total}} = \int_{c} \mathbf{\bar{F}} \cdot \hat{\mathbf{n}} \, \mathrm{d}s \tag{2}
$$

where \overline{F} is the force vector and $\hat{\mathbf{n}}$ is the unit normal to the direction of the force.

We will consider the case of a droplet wetted to a glass plate placed on a hydrophobic $(CA > 90^{\circ})$ substrate. For small droplet volumes, the droplet is well approximated by a prism with the cross section of the glass plate (Crane et al. [2010\)](#page-8-15). For the simple cases of a rectangular plate or a circular plate that is halfway over the energized electrode (Fig. [1\)](#page-1-0), the total electrowetting force can be combined with the Young–Lippmann equation and simplified to:

$$
F = \frac{\varepsilon_0 \times \varepsilon}{2 \times \delta} \times V^2 \times L_{\text{eff}} = (\cos (\theta_{\text{EW}}) - \cos (\theta_{\text{Y}})) \times \gamma \times L_{\text{eff}},
$$

(3)

where θ_{EW} is the apparent contact angle under voltage, θ _Y is the equilibrium contact angle when $V = 0$, γ is the droplet/ambient interfacial tension, and L_{eff} is the length of the droplet normal to the force direction at the boundary between the two electrodes. Alternatively, the force can be found by calculating the derivative of the system energy with respect to a displacement in the direction of the force. For the case of a square droplet, the change in *L*eff with voltage and position is negligible so that the energy change in the system is the electrical energy stored in the capacitor formed between the droplet and the electrode (Crane et al. [2010\)](#page-8-15). The capacitive energy stored below a square droplet is (see Fig. [1](#page-1-0)):

Fig. 1 A square droplet is created by placing a glass plate over it. The droplet assumes the shape of the glass plate. One side of the droplet is grounded. When a voltage is applied to the other electrode, the contact line moves only slightly, but a force is still applied to the glass plate

Fig. 2 Force measurement setup. The illustration on *top* is the measurement system viewed form the side. The *lower left* is a magnified view of the force sensor from top. The *lower right* is the top view of the glass plate with droplets and oil under the plate

$$
E = \frac{1}{2} \times C \times V^2 = \frac{1}{2} \times \left(\frac{\varepsilon_0 \times \varepsilon \times x \times L_{\text{eff}}}{\delta} \right) \times V^2, \quad (4)
$$

where $(x \times L)$ is the area of the droplet that's covering the working electrode. Taking:

$$
F = \frac{dE}{dx} = \frac{1}{2} \left(\frac{\varepsilon_0 \times \varepsilon}{\delta} \right) \times V^2 \times L_{\text{eff}},
$$
 (5)

Eq. [3](#page-1-1) is recovered. It is important to note that according to Eq. [5,](#page-2-0) the force is independent of the interfacial tension of the fluids used. So below the contact angle saturation, the force should only be a function of the voltage applied.

3 Experimental setup

3.1 Electrowetting force measurement

The experimental configuration is illustrated in Fig. [2.](#page-1-2) A force sensor (NanoScience Instruments FT-270, resolution 2 μ N) was bonded to a thin glass fiber (diameter ~5 μ m) using cyanoacrylate. On the other end of the fiber, a glass plate (13.5 \times 4.5 \times 0.1 mm) was attached using the same method. The glass plate was patterned with 1 μ m Cytop[®] to define two hydrophilic regions separated by a hydrophobic region. One droplet is placed in each hydrophilic region. Due to the uneven pressure distribution inside the droplet under electrowetting actuation, the glass plate tends to tilt when a voltage was applied. Therefore, only the droplet away from the force sensor was actuated during force measurements, and the droplet which was closer to the sensor provided a counter moment to the plate to prevent rotation. As a result, the lateral force of electrowetting was translated through the droplet to the top glass plate and measured by the force sensor with negligible plate tilting.

The substrate was fabricated by evaporating aluminum (400 nm) onto clean glass slides using electron beam deposition. The aluminum was patterned to form two electrodes using photolithography. A 2 μ m (\pm 0.15 μ m, measured by Alpha-Step profilometer) Parylene C coating was deposited using a Parylene labcoater (Specialty Coating System, PSD2010). Finally, a 30-nm Cytop® top coat was applied to render the substrate hydrophobic. Our group and others have reported anodic electrowetting with weak acid and aluminum improves electrowetting reliability (Khodayari et al. [2012;](#page-8-16) Dhindsa et al. [2011\)](#page-8-17). Therefore, the electrolyte base was chosen to be 0.1 M citric acid. Nonionic, water-soluble surfactant (Tergitol™ NP-8, CMC 61 ppm, DOW chemical company) was added with 0.001 and 0.005 % by weight concentration. Ambient phase used was silicone oil (OS-30, Dow Corning) or *n*-hexadecane (99 % pure, Alfa Aesar).

The experimental procedures are listed as follows: (1) Before each test run, a scratch was made in the Parylene

Fig. 3 Experimental procedure. Droplets of testing fluids are deposited first onto the top plate. Then the plate is lowered to touch the electrowetting substrate. Ambient fluid is then added. When a voltage is applied, the force on the plate is measured and recorded

covering the grounding electrode to provide electrical ground to the droplet. (2) The fluid of interest (a total of two droplets with volume of 10 µL each) was deposited onto the two wetting regions on the top plate manually using a pipettor. (3) The glass plate was lowered onto the substrate to allow the droplets to touch the surface. (4) Ambient fluid (10 μ L) was pipetted to the gap between the glass plate and substrate. (5) A DC voltage ramp was applied at 1 V/0.2 s, and the reading from the force sensor was collected as well as the applied potential (see Fig. [3](#page-2-1)). A total of five tests were performed, and each test was done on a new location on the substrate. The total volume of the fluid used was fixed to be 30 μ L during all experiments, and the gap height was maintained by the surface tension of the oil/air interface. Therefore, no significate height change was observed with different surfactant concentration.

3.2 Contact angle measurements

Contact angle measurement was taken on a goniometer fitted with a digital camera, and the images were processed using ImageJ software. Contact angle was measured with the same voltage ramp as the force measurements. For solutions with surfactant, the voltage ramp was stopped at 80 V. For all other measurements, the voltage was ramped to 120 V. Again, a total of five tests were performed for each solution.

4 Results and discussion

4.1 Direct force measurements

The measured actuation force is plotted versus the applied voltage. As the figure shows, regardless of the

Fig. 4 Measured electrowetting force versus the applied voltage. The *plot on the left* shows the tests performed using *n*-hexadecane as the ambient fluid and the *plot on the righ*t using OS-30 silicone oil. No surfactant: 0.1 M citric acid. 0.001 % surfactant and 0.005 %

Fig. 5 Measured contact angle versus voltage applied. The *figure on the left* shows tests performed in *n*-hexadecane ambient, and the *figure on the right* shows tests performed in OS ambient. No surfactant: 0.1 M citric acid. 0.001 % surfactant and 0.005 % surfactant: the per-

concentration of the surfactant, the measured force followed the same slope until saturation. The peak force each fluid can achieve was proportional to the interfacial surface energy (see Fig. [4](#page-3-0)).

4.2 Contact angle measurements

The measured contact angle is plotted versus voltage applied (see Fig. [5\)](#page-3-1). All combinations of droplet fluid and ambient fluid showed contact angle variation from ~170° to $\sim 60^\circ$. Surface tension (mN/m) was extracted from the contact angle measurements using methods described by Banpurkar et al. ([2008\)](#page-8-18), and the values are tabulated in Table [1.](#page-3-2)

4.3 Comparison between the measured force and the force calculated from contact angle

In order to relate the measured force to the contact angle, the extracted interfacial tension and the average values of

surfactant: the percentage concentration by weight added to the base solution. The average values of five tests for each material combination are presented with the *error bars* showing the standard deviation of the results

centage concentration by weight added to the base solution. The average of five tests is presented. *Error bars* show the standard deviation of the results

Table 1 Surface tension values (mN/m) extracted from contact angle measurements

	n -Hexadecane ambient	OS-30 ambient
0.1 M citric acid	30.9 ± 2.3	36.0 ± 3.6
0.001% by weight Tergitol added	$17.2 + 1.2$	18.9 ± 1.1
0.005% by weight Tergitol added	10.7 ± 0.7	12.5 ± 1.1

The rows are the actuation fluids, and the columns are the ambient oil. Five repetitions are performed for each test, and the average value and their standard deviation are listed

the measured contact angle, along with the plate width $(L_{eff} = 4.5$ mm), were used to calculate the electrowetting force using Eq. [1.](#page-1-3) These results are compared to the measured electrowetting force in Fig. [6.](#page-4-0)

The measured electrowetting force agrees very well with the calculated force below the saturation voltage. The

Fig. 6 The average of measured electrowetting force is plotted against the average calculated force from contact angle. The relative surface tension values are used instead of the surfactant concentration. The *straight line with the slope* of 1 provides and comparison standard for those two methods used

measured force for most fluids exceeded predictions as the voltage approached the saturation voltage before dropping below the prediction as the contact angle saturation voltage is exceeded. Although the cause of contact angle saturation is still under intense debate (Papathanasiou and Boudouvis [2005](#page-8-19); Chevalliot et al. [2012\)](#page-8-20), it is possible that in this case, geometry changes of the droplet could cause this increases due to a small increase in *L*_{eff} prior to saturation.

The fact that the measured force dropped below the predicted force after contact angle saturation was somewhat difficult to interpret. It was suggested by Jones ([2005\)](#page-8-21) that the electrowetting force can still increase even after contact angle saturation. Jones also stated that there was no direct evidence to assume the contact angle saturation

was limiting the electrowetting force. However, our measurements show only small excess of force near the contact angle saturation point after which the force drops below predictions. Thus, the contact angle saturation is a good prediction of the force saturation limits in these geometries. It is possible that these effects are due to size and geometric effects such as droplet spreading on the electrode and/or dewetting from the plate above the saturation voltage. Further work is necessary to address this force limit.

To consider the data differently, the measured forces after the onset of saturation were first normalized by the effective length $(L = 4.5$ mm); then plotted against the electrowetting number $(\eta = \frac{1}{2} \left(\frac{\varepsilon_0 \times \varepsilon}{\gamma \times \delta} \right) \times V^2)$ to show the dependence of the force with surface tension of the fluids, and then the same normalized forces were plotted against the surface tension times the electrowetting number $(\gamma \times \eta = \frac{1}{2} \left(\frac{\varepsilon_0 \times \varepsilon}{\delta} \right) \times V^2)$ to show the voltage dependence of the electrowetting force, as shown in Fig. [7.](#page-4-1) The figure highlights the design considerations for EWOD-based devices.

At the same electrowetting number, higher surface tension fluids provide higher actuation force (Fig. [7](#page-4-1)a). While low energy fluids require less voltage to reach saturation, the actuation force is much larger with high surface energy fluids. Additionally, the electrowetting forces produced by all tested fluids follow the same linear relationship between force and V^2 regardless of the interfacial tension of the fluid as predicted (Fig. [7](#page-4-1)b). So the actuation force is only dependent on the voltage applied prior to saturation. Interestingly, the electrowetting force/length exceeded the interfacial energy of the fluid for all tested fluids, many by 50 %. Even with the uncertainty of the contact line length during the force experiments, the applied force/length has clearly exceeded the interfacial energy of the fluids. Thus, it is likely that the force was limited by either the stability of the droplet/substrate interface or the wetting force of the droplet to the glass plate on top. By decreasing the volume of the droplets and/or enhancing wetting to the top glass plate by adding roughness features to the plate, the electrowetting force might be increased further.

Fig. 7 Measured unit force before saturation plotted against **a** electrowetting number (*η*), *left graph*, **b** surface tension times electrowetting number ($\gamma \times \eta$), *right graph*. Interfacial tension values are listed instead of material combination

O35.99 mN/m ●30.94 mN/m ◆18.86 mN/m ◆17.2 mN/m □12.47 mN/m ■10.71 mN/m

In summary, for electrowetting based actuators, if lower voltage requirements are the primary design consideration, lower surface tension fluids should be used. If the maximum actuation force is the goal of the device, then higher surface tension fluids should be utilized.

5 Considerations for electrowetting velocity

As discussed above, actuation velocity is important to many electrowetting applications. Even where the force is the primary metric of concern, actuation velocity determines the response speed and actuator bandwidth. If the droplet were a rigid body, higher forces would be expected to produce higher accelerations and higher peak velocity. However, Lu et al. ([2007\)](#page-8-22) have reported that the center of mass of the EWOD droplet reached higher velocity with higher electrowetting number which is contrary to this force-based prediction.

To investigate the impact of electrowetting force on actuation speed, two additional sets of experiments were performed to compare velocities of different surface energy fluids in the traditional closed electrowetting configuration with a grounded top plate to the fixed-shape droplet case studied here. Patterned substrates were fabricated using the same method described in earlier section. The size of the electrodes was 4×4.5 mm. For the first set of experiments, a cover plate coated with indium tin oxide (ITO) was used to provide electrical ground to the droplet. The ITO-covered glass slides were also coated with 30 nm Cytop® to ensure the same hydrophobic surface property. The gap between the top plate and the substrate $(400 \mu m)$ was maintained by a plastic shim. The volume of the droplet was 10 µL, and the ambient fluid used was OS-30 oil. An initial voltage was applied to the electrode on the left at time $\langle 0 \rangle$ to maintain the position of the droplet at the beginning; then the voltage was switched to the electrode on the right at time >0. A digital camera above was triggered at 50 Hz to capture the evolution of the droplet as it moved toward the active electrode.

5.1 Free deforming droplet

In our experiments, lower surface tension droplets reached the active electrode much faster than high surface tension droplet under the same applied voltage. This is true even when the applied voltage is well above the saturation voltage of the low energy fluid. The images show that the low surface tension droplets were able to stretch more than the higher surface tension droplets at the same applied voltage (Fig. [8\)](#page-5-0). The characterization of the droplet deformation is beyond the scope of this paper, but contact line friction, viscosity, and contact angle hysteresis all contribute to this

Fig. 8 Comparing the motion of free deforming droplets sandwiched between two plates during electrowetting actuation. The *top row* is high surface tension fluid ($\gamma = 36.0$ mN/m), and the *bottom row* is low surface tension fluid ($\gamma = 18.9$ mN/m). The time which the image is taken is listed in seconds. The low surface tension fluid deformed much more during actuation and conformed to the electrode shape much easier. The *scale bar* is 5 mm. Applied voltage: 70 V, ambient fluid: OS-30. Droplet is grounded through an ITO-covered top plate

behavior (Shabani and Cho [2013;](#page-8-23) Song et al. [2008](#page-8-24); Nelson and Kim [2012](#page-8-25); Snoeijer and Andreotti [2013\)](#page-8-26). Of all those factors, the dynamic contact angle hysteresis and the viscosity of both the ambient fluid and the droplet are thought to be the most relevant to the deformation of the droplets (see later section about dynamic contact angles and contact line friction). Under electrowetting actuation, the leading contact angle deforms under the applied potential and the contact line started to move. But the contact line at the top leading edge and the trailing edges (both top and bottom) was pinned due to contact angle hysteresis. The induced internal flow and the shear stress developed due to the viscosity contrast of the ambient, and droplet causes the droplet to deform. The deformation on the leading edge of the droplet increases the effective contact line length on the active electrode to increase the force. Simultaneously, the low energy surface more readily deforms in response to the resistance of the ambient fluid to reduce the drag force on the droplet. Both effects would act to increase the droplet actuation velocity. The first effect would increase the force on the low energy droplet, while the second would reduce the drag. Additionally, the contact line hysteresis or contact line friction is often proportional to the surface energy. So the larger actuation force/contact line length may be partially offset by these contact line losses. These observations are consistent with the results of others (Lu et al. [2007;](#page-8-22) Ren et al. [2002\)](#page-8-27), and additional studies are needed to provide a complete understanding. Given that lowering the surface tension can lower the operational voltage in the EWOD device, low surface tension fluids are favorable for the free droplets.

If the higher speed of low surface energy droplets is related to their ability to change shape readily, this advantage should decrease or be reversed in the case of fixedshape droplets. As fixed geometries are able to exert the largest forces, this condition is important for maximizing actuation speed. In this case, high surface tension fluid would be expected to provide both high peak force and higher velocity. As a validation, velocity of fixed-shape droplets of different fluid types was measured in the second set of experiments.

5.2 Fixed-shape droplet

The same electrode design was used, but the top cover plate was replaced with a free circular glass plate (diameter 8 mm, thickness 100 µm) that was wet by the EWOD droplet. A scratch in the Parylene on one electrode was

Fig. 9 Plate speed under electrowetting actuation. A circular plate is carried by the EWOD droplet. The relative displacement of the plate (mm) is plotted against the time (ms) after the voltage is applied. High surface tension fluid is 0.1 M citric acid (36.0 mN/m), and the low surface tension fluid (18.9 mN/m) is 0.001 % surfactant by weight. The maximum voltage (70 V) is below both fluids saturation voltage. The average velocity of the plate is listed on the *right*. The average value of three tests are presented, and the *error bars* are the standard deviation of the data

Fig. 10 Normalized friction force versus velocity. The velocity for the tests is 2.5, 5, 7.5 and 15 mm/s for all fluids with the additional 30 mm/s for the high surface tension fluid only. The *squares* are the low surface tension fluids ($\gamma = 18.9$ mN/m), and the *circles* are high surface tension fluid (γ = 36.0 mN/m). Each data point represents the average of three runs, and the standard deviation is presented. The *inset* is the same force plotted against the capillary number (Ca)

used to provide electrical ground. The oversized plate forced the droplet to wet the top plate and remain circular during motion. Also, the effective length of the droplet was constrained due to the fact that the plate diameter (8 mm) is much larger than the electrode width (4.5 mm). The experiments were performed in air with just 2 µL silicon oil (OS-30) at the interface to minimize contact line friction. Although the experiments were done in air, the oil shell encapsulates the droplet/substrate interface so the electrowetting force should still depend on the droplet/oil surface tension values. The combined volume of the droplet and ambient oil resulted a gap height of 400 µm. Potential was applied to one of the electrodes, and the movement of the droplet was captured at 50 frames/second. Afterward, the images were analyzed using a MATLAB routine to track the circular plate's position and the centroid of the plate was extracted for each frame. The displacement of the glass plate is plotted against the time in Fig. [9](#page-6-0).

At low voltage (50 V), the droplet displacement was similar for both high and low surface tension fluids. The low surface tension fluid moved slightly faster than the high surface tension fluid. It is possible that the same volume droplet would have a slightly larger contact area with lower surface tension. At high voltage (70 V), the velocity increased for both fluids. However, the constraining top plate limits the spreading and the higher surface energy fluid achieved much faster motion as would be expected from the EW force measurements. Thus, high surface energy fluids are preferred for electrowetting actuations when high velocity of a constrained droplet is needed or large actuation forces are desired.

5.3 Friction effect

As discussed earlier, the forces oppose the motion is due to the combined effect of viscosity of the fluid, the surface tension, and the contact angle variation during motion (dynamic contact angle). A large number of detailed studies has been conducted for droplets with a moving contact line for both droplet spreading (Shikhmurzaev [1993](#page-8-28); Blake [2006](#page-8-29); Snoeijer and Andreotti [2013\)](#page-8-26) and electrowetting forced wetting (Blake et al. [2000;](#page-8-30) Decamps and De Coninck [2000](#page-8-31); Nelson et al. [2011\)](#page-8-32). The frictional force is usually thought to be proportional to the capillary number Ca $(Ca = \frac{\mu \times U}{\gamma})$, where μ the viscosity and *U* the contact line speed.

For a fixed-shape droplet (in our case, a thin circular cylinder shaped droplet), the friction variation can be measured by simply drag the droplet at fixed speed. Refer back to Fig. [2](#page-1-2), the same force measurement setup was used to drag the same fixed-shape droplet across the same hydrophobic substrate. A linear stage (UTS100CC, Newport Corp) was used to move the substrate at given velocity,

and the sensor was fixed to the support. The tests were performed for low and high surface tension fluids at 2.5, 5, 7.5 and 15 mm/s. The initial inertial effect was discarded, and only the forces at steady state velocities were reported. The measured forces were normalized by the plate diameter (8 mm) and then plotted against the velocity for each combination (Fig. [10\)](#page-6-1), and the insert shows the normalized force versus the capillary number Ca (using 1 mPa S for μ).

During the experiments, a dynamic force oscillation was observed around Ca \sim 4 × 10⁻⁴, but the force variation was low (~0.5 mN/m). Plate tilting due to viscous shear was only observed for low surface tension fluid at Ca ~8 \times 10⁻⁴ (the last data point of low γ); also, both the drag force and the dynamic force oscillations started to increase after the average speed became stable for that particular case. The friction force for high surface tension fluid increased linearly with the capillary number. However, the friction force for low surface tension fluid had much larger gain when the capillary number increased to Ca $\sim 8 \times 10^{-4}$. In the dynamic contact angle study conducted by Nelson et al. [\(2011](#page-8-32)), the dependency of contact line friction in terms of dynamic contact angle hysteresis without electrowetting was fairly weak at Ca <5 \times 10⁻⁴ and the contact angle hysteresis increased after Ca > 1×10^{-3} for water in air. Our experiments observed the same trend for low surface tension fluids where a large force increase was seen after $Ca > 5 \times 10^{-4}$. It is unclear why higher surface tension fluids did not follow the same trend. It is possible that in our experiments, the top plate was carried by the droplet and the weight of the glass plate contributed to the effect. It is also possible that surface tension changes the slope. Since the plate is not rigidly constrained, it could undergo some tilting that might impact the measured forces, but the plate appeared to remain parallel to the substrate during testing.

Without provoking the hydrodynamic or molecular kinetic theory presented in earlier references (Shikhmurzaev [1993;](#page-8-28) Blake [2006](#page-8-29); Snoeijer and Andreotti [2013\)](#page-8-26), the data still provide some insight to the interpolation to earlier speed experiments. First, the friction force at given measured velocity (Fig. [9\)](#page-6-0) was extracted using fitted line from Fig. [10.](#page-6-1) Assuming the measured friction forces represent the total force oppose the motion during electrowetting actuation, Table [2](#page-7-0) summarizes the forces and their differences under actuation. The highly nonlinear nature of the residual force (the difference between the applied force and the friction force) seems to indicate there are other additional dissipation mechanism which is related to both the surface tension and the velocity. Perhaps like it was pointed out in (Nelson et al. [2011](#page-8-32)), the stick slip behavior at high electrowetting number actuation has additional impact in the friction force and the electrowetting changed the localized flow condition around the contact line. Or it could be the assumption of measured friction force at steady state did not match the transient behavior of electrowetting actuation. More advanced analyzing methods is needed for the future study.

At low speed, both the low and high surface tension fluids were under the same actuation force. The contact line friction was slightly higher for the low surface tension droplet. However, the low surface tension droplet moved faster as seen in Fig. [8.](#page-5-0) When the contact line speed increased beyond Ca ~3 \times 10⁻⁴, the friction force increased as the speed of the contact line increased. The low surface tension droplet experienced much more friction force than the high surface tension droplet. The additional friction force limits the low surface tension droplet's speed at high voltage (70 V). For high surface tension fluid, the linear relationship with speed follows a less steep slope. So the high surface tension droplet can travel faster at high voltage. Since high surface tension fluids can reach higher velocity at given capillary number, they should be used for fixed-shape droplet to maximize both the actuation force and speed.

6 Conclusion

We have measured the electrowetting force by confining the geometry of the droplet. Below contact angle saturation, the measured force agrees well with the force predicted from contact angle measurements. The measured electrowetting force exceeds the predicted saturation point but declines with increased voltage beyond saturation. Higher surface energy fluids achieve much larger forces than low surface energy fluids. However, droplet velocity is not directly related to the electrowetting force. Free droplet velocity is higher for lower surface energy fluids than higher surface energy fluids. It appears that droplet deformation has large impact in droplet transportation speed in EWOD of free droplets and the electrowetting number should be used to

design EWOD devices for moving droplets as previously reported. However, for a droplet with fixed shape, the maximum velocity increases with higher surface tension fluids due to the limiting contact line friction force. So as a rule, for higher force/speed of EWOD actuators, higher surface tension fluids should be used.

Acknowledgments The work is supported in part by the National Science Foundation thorough Grant No. CMMI-113075.

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